

UF2N30Z

2A, 300V **N-CHANNEL POWER MOSFET**

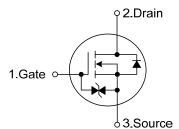
DESCRIPTION

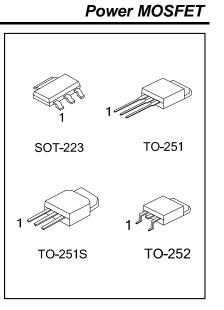
The UTC UF2N30Z is an N-channel enhancement mode Power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance, low gate charge and superior switching performance.

FEATURES

- * R_{DS(ON)} < 2.5Ω @ V_{GS}=10V, I_D=1A
- * High switching speed
- * Typically 4nC low gate charge
- * 100% avalanche tested

SYMBOL





ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Deaking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
_	UF2N30ZG-AA3-R	SOT-223	G	D	S	Tape Reel	
UF2N30ZL-TM3-T	UF2N30ZG-TM3-T	TO-251	G	D	S	Tube	
UF2N30ZL-TMS-T	UF2N30ZG-TMS-T	TO-251S	G	D	S	Tube	
UF2N30ZL-TN3-T	UF2N30ZG-TN3-T	TO-252	G	D	S	Tube	
Note: Pin Assignment: G: Gate D: Drain S: Source							

UF2N30ZG-AA3-R (1) R: Tape Reel, T: Tube (1)Packing Type (2) AA3: SOT-223, TM3: TO-251, TMS: TO-251S (2)Package Type TN3: TO-252 (3)Green Package (3) L: Lead Free, G: Halogen Free and Lead Free

MARKING



ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	300	V	
Gate-Source Voltage		V _{GSS}	±20	V	
	Continuous	I _D	2	А	
Continuous Drain Current	Pulsed	I _{DM}	8	А	
Avalanche Energy		E _{AS}	52	mJ	
	SOT-223		0.8		
Power Dissipation (T _C =25°C)	TO-251/TO-251S TO-252	P _D	1.13	W	
Junction Temperature		ТJ	+150		
Storage Temperature Range		T _{STG}	-55~+150	°C	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

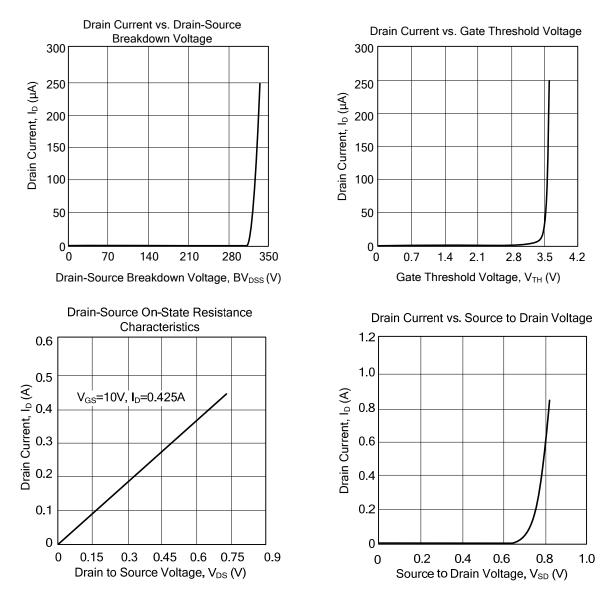
ELECTRICAL CHARACTERISTICS

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PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS			•	_			
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V				V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =300V			1	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} =+20V, V _{DS} =0V			10	μA
	Reverse		V _{GS} =-20V, V _{DS} =0V			-10	μA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	I _D =250μA			4	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =1A			2.5	Ω
DYNAMIC PARAMETERS							
Input Capacitance		CISS			200		pF
Output Capacitance Reverse Transfer Capacitance		C _{OSS}	V _{GS} =0V, V _{DS} =25V, f=1MHz		90		pF
		C _{RSS}			30		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_{G}			4	6	nC
Gate to Source Charge		Q_{GS}	V_{DD} =50V, I_{D} =1.3A,		0.64		nC
Gate to Drain Charge		Q_{GD}	l _G =100μA, V _{GS} =10V 0.64 1.6			nC	
Turn-ON Delay Time		t _{D(ON)}			29	35	ns
Rise Time		t _R	V _{DD} =30V, I _D =0.5A,		110	125	ns
Turn-OFF Delay Time		t _{D(OFF)}	R _G =25Ω, V _{GS} =0~10V		50	56	ns
Fall-Time		t⊨			99	120	ns
SOURCE- DRAIN DIODE RATII	NGS AND	CHARACTER	RISTICS				
Maximum Body-Diode Continuous Current		Is				2	Α
Maximum Body-Diode Pulsed Current		I _{SM}				8	Α
Drain-Source Diode Forward Voltage		V_{SD}	I _S =2A			1.3	V

UNISONIC TECHNOLOGIES CO., LTD

UF2N30Z

TYPICAL CHARACTERISTICS



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